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### Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications,

#### Details

Product Status	Obsolete
Number of LABs/CLBs	1452
Number of Logic Elements/Cells	-
Total RAM Bits	-
Number of I/O	113
Number of Gates	24000
Voltage - Supply	2.25V ~ 5.25V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 85°C (TA)
Package / Case	144-LQFP
Supplier Device Package	144-TQFP (20x20)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/microchip-technology/a54sx16a-1tq144i">https://www.e-xfl.com/product-detail/microchip-technology/a54sx16a-1tq144i</a>

## Logic Module Design

The SX-A family architecture is described as a “sea-of-modules” architecture because the entire floor of the device is covered with a grid of logic modules with virtually no chip area lost to interconnect elements or routing. The Actel SX-A family provides two types of logic modules: the register cell (R-cell) and the combinatorial cell (C-cell).

The R-cell contains a flip-flop featuring asynchronous clear, asynchronous preset, and clock enable, using the S0 and S1 lines control signals (Figure 1-2). The R-cell registers feature programmable clock polarity selectable on a register-by-register basis. This provides additional flexibility while allowing mapping of synthesized functions into the SX-A FPGA. The clock source for the R-cell can be chosen from either the hardwired clock, the routed clocks, or internal logic.

The C-cell implements a range of combinatorial functions of up to five inputs (Figure 1-3). Inclusion of the DB input and its associated inverter function allows up to 4,000

different combinatorial functions to be implemented in a single module. An example of the flexibility enabled by the inversion capability is the ability to integrate a 3-input exclusive-OR function into a single C-cell. This facilitates construction of 9-bit parity-tree functions with 1.9 ns propagation delays.

## Module Organization

All C-cell and R-cell logic modules are arranged into horizontal banks called Clusters. There are two types of Clusters: Type 1 contains two C-cells and one R-cell, while Type 2 contains one C-cell and two R-cells.

Clusters are grouped together into SuperClusters (Figure 1-4 on page 1-3). SuperCluster 1 is a two-wide grouping of Type 1 Clusters. SuperCluster 2 is a two-wide group containing one Type 1 Cluster and one Type 2 Cluster. SX-A devices feature more SuperCluster 1 modules than SuperCluster 2 modules because designers typically require significantly more combinatorial logic than flip-flops.

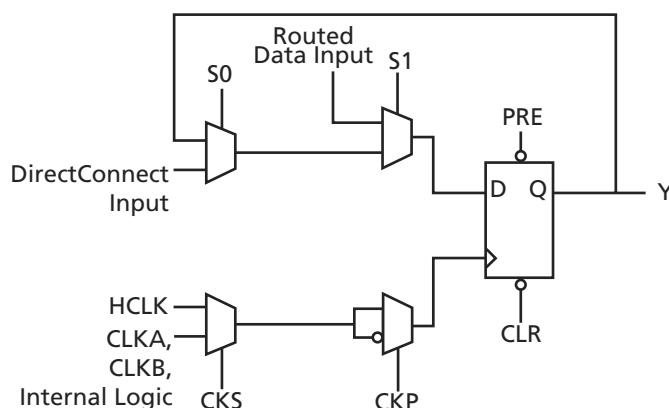


Figure 1-2 • R-Cell

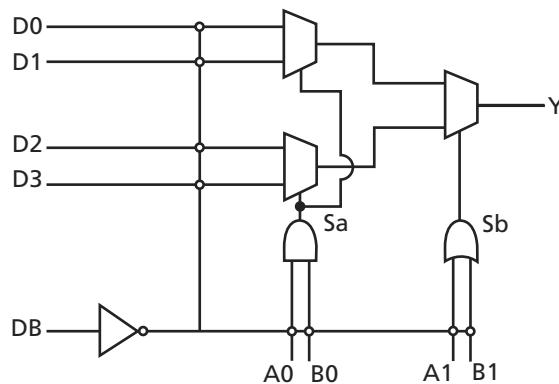


Figure 1-3 • C-Cell

## Other Architectural Features

### Technology

The Actel SX-A family is implemented on a high-voltage, twin-well CMOS process using  $0.22\text{ }\mu\text{/ }0.25\text{ }\mu$  design rules. The metal-to-metal antifuse is comprised of a combination of amorphous silicon and dielectric material with barrier metals and has a programmed ('on' state) resistance of  $25\text{ }\Omega$  with capacitance of  $1.0\text{ fF}$  for low signal impedance.

### Performance

The unique architectural features of the SX-A family enable the devices to operate with internal clock frequencies of 350 MHz, causing very fast execution of even complex logic functions. The SX-A family is an optimal platform upon which to integrate the functionality previously contained in multiple complex programmable logic devices (CPLDs). In addition, designs that previously would have required a gate array to meet performance goals can be integrated into an SX-A device with dramatic improvements in cost and time-to-market. Using timing-driven place-and-route tools, designers can achieve highly deterministic device performance.

### User Security

Reverse engineering is virtually impossible in SX-A devices because it is extremely difficult to distinguish between programmed and unprogrammed antifuses. In addition, since SX-A is a nonvolatile, single-chip solution, there is no configuration bitstream to intercept at device power-up.

The Actel FuseLock advantage ensures that unauthorized users will not be able to read back the contents of an Actel antifuse FPGA. In addition to the inherent strengths of the architecture, special security fuses that prevent internal probing and overwriting are hidden throughout the fabric of the device. They are located where they cannot be accessed or bypassed without destroying access to the rest of the device, making both invasive and more-subtle noninvasive attacks ineffective against Actel antifuse FPGAs.

Look for this symbol to ensure your valuable IP is secure (Figure 1-11).



Figure 1-11 • FuseLock

For more information, refer to Actel's *Implementation of Security in Actel Antifuse FPGAs* application note.

### I/O Modules

For a simplified I/O schematic, refer to Figure 1 in the application note, *Actel eX, SX-A, and RTSX-S I/Os*.

Each user I/O on an SX-A device can be configured as an input, an output, a tristate output, or a bidirectional pin. Mixed I/O standards can be set for individual pins, though this is only allowed with the same voltage as the input. These I/Os, combined with array registers, can achieve clock-to-output-pad timing as fast as 3.8 ns, even without the dedicated I/O registers. In most FPGAs, I/O cells that have embedded latches and flip-flops, requiring instantiation in HDL code; this is a design complication not encountered in SX-A FPGAs. Fast pin-to-pin timing ensures that the device is able to interface with any other device in the system, which in turn enables parallel design of system components and reduces overall design time. All unused I/Os are configured as tristate outputs by the Actel Designer software, for maximum flexibility when designing new boards or migrating existing designs.

SX-A I/Os should be driven by high-speed push-pull devices with a low-resistance pull-up device when being configured as tristate output buffers. If the I/O is driven by a voltage level greater than  $V_{CCA}$  and a fast push-pull device is NOT used, the high-resistance pull-up of the driver and the internal circuitry of the SX-A I/O may create a voltage divider. This voltage divider could pull the input voltage below specification for some devices connected to the driver. A logic '1' may not be correctly presented in this case. For example, if an open drain driver is used with a pull-up resistor to 5 V to provide the logic '1' input, and  $V_{CCA}$  is set to 3.3 V on the SX-A device, the input signal may be pulled down by the SX-A input.

Each I/O module has an available power-up resistor of approximately  $50\text{ k}\Omega$  that can configure the I/O in a known state during power-up. For nominal pull-up and pull-down resistor values, refer to Table 1-4 on page 1-8 of the application note *Actel eX, SX-A, and RTSX-S I/Os*. Just slightly before  $V_{CCA}$  reaches 2.5 V, the resistors are disabled, so the I/Os will be controlled by user logic. See Table 1-2 on page 1-8 and Table 1-3 on page 1-8 for more information concerning available I/O features.



## Guidelines for Estimating Power

The following guidelines are meant to represent worst-case scenarios; they can be generally used to predict the upper limits of power dissipation:

Logic Modules (m) = 20% of modules

Inputs Switching (n) = Number inputs/4

Outputs Switching (p) = Number of outputs/4

CLKA Loads (q1) = 20% of R-cells

CLKB Loads (q2) = 20% of R-cells

Load Capacitance (CL) = 35 pF

Average Logic Module Switching Rate (fm) = f/10

Average Input Switching Rate (fn) = f/5

Average Output Switching Rate (fp) = f/10

Average CLKA Rate (fq1) = f/2

Average CLKB Rate (fq2) = f/2

Average HCLK Rate (fs1) = f

HCLK loads (s1) = 20% of R-cells

To assist customers in estimating the power dissipations of their designs, Actel has published the *eX, SX-A and RT54SX-S Power Calculator* worksheet.

Table 2-22 • A54SX16A Timing Characteristics  
 (Worst-Case Commercial Conditions  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 2.25\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

<b>Parameter</b>	<b>Description</b>	<b>-3 Speed*</b>	<b>-2 Speed</b>	<b>-1 Speed</b>	<b>Std. Speed</b>	<b>-F Speed</b>	<b>Units</b>
		<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	
<b>Dedicated (Hardwired) Array Clock Networks</b>							
$t_{HCKH}$	Input Low to High (Pad to R-cell Input)	1.2	1.4	1.6	1.8	2.8	ns
$t_{HCKL}$	Input High to Low (Pad to R-cell Input)	1.0	1.1	1.2	1.5	2.2	ns
$t_{HPWH}$	Minimum Pulse Width High	1.4	1.7	1.9	2.2	3.0	ns
$t_{HPWL}$	Minimum Pulse Width Low	1.4	1.7	1.9	2.2	3.0	ns
$t_{HCKSW}$	Maximum Skew	0.3	0.3	0.4	0.4	0.7	ns
$t_{HP}$	Minimum Period	2.8	3.4	3.8	4.4	6.0	ns
$f_{HMAX}$	Maximum Frequency	357	294	263	227	167	MHz
<b>Routed Array Clock Networks</b>							
$t_{RCKH}$	Input Low to High (Light Load) (Pad to R-cell Input)	1.0	1.2	1.3	1.6	2.2	ns
$t_{RCKL}$	Input High to Low (Light Load) (Pad to R-cell Input)	1.1	1.3	1.5	1.7	2.4	ns
$t_{RCKH}$	Input Low to High (50% Load) (Pad to R-cell Input)	1.1	1.3	1.5	1.7	2.4	ns
$t_{RCKL}$	Input High to Low (50% Load) (Pad to R-cell Input)	1.1	1.3	1.5	1.7	2.4	ns
$t_{RCKH}$	Input Low to High (100% Load) (Pad to R-cell Input)	1.3	1.5	1.7	2.0	2.8	ns
$t_{RCKL}$	Input High to Low (100% Load) (Pad to R-cell Input)	1.3	1.5	1.7	2.0	2.8	ns
$t_{RPWH}$	Minimum Pulse Width High	1.4	1.7	1.9	2.2	3.0	ns
$t_{RPWL}$	Minimum Pulse Width Low	1.4	1.7	1.9	2.2	3.0	ns
$t_{RCKSW}$	Maximum Skew (Light Load)	0.8	0.9	1.0	1.2	1.7	ns
$t_{RCKSW}$	Maximum Skew (50% Load)	0.8	0.9	1.0	1.2	1.7	ns
$t_{RCKSW}$	Maximum Skew (100% Load)	1.0	1.1	1.3	1.5	2.1	ns

**Note:** \*All -3 speed grades have been discontinued.

Table 2-25 • A54SX16A Timing Characteristics  
 (Worst-Case Commercial Conditions  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 2.25\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

<b>Parameter</b>	<b>Description</b>	<b>-3 Speed<sup>1</sup></b>	<b>-2 Speed</b>	<b>-1 Speed</b>	<b>Std. Speed</b>	<b>-F Speed</b>	<b>Units</b>
		<b>Min. Max.</b>	<b>Min. Max.</b>	<b>Min. Max.</b>	<b>Min. Max.</b>	<b>Min. Max.</b>	
<b>2.5 V LVC MOS Output Module Timing<sup>2, 3</sup></b>							
$t_{DLH}$	Data-to-Pad Low to High	3.4	3.9	4.5	5.2	7.3	ns
$t_{DHL}$	Data-to-Pad High to Low	2.6	3.0	3.3	3.9	5.5	ns
$t_{DHLS}$	Data-to-Pad High to Low—low slew	11.6	13.4	15.2	17.9	25.0	ns
$t_{ENZL}$	Enable-to-Pad, Z to L	2.4	2.8	3.2	3.7	5.2	ns
$t_{ENZLS}$	Data-to-Pad, Z to L—low slew	11.8	13.7	15.5	18.2	25.5	ns
$t_{ENZH}$	Enable-to-Pad, Z to H	3.4	3.9	4.5	5.2	7.3	ns
$t_{ENLZ}$	Enable-to-Pad, L to Z	2.1	2.5	2.8	3.3	4.7	ns
$t_{ENHZ}$	Enable-to-Pad, H to Z	2.6	3.0	3.3	3.9	5.5	ns
$d_{TLH}^4$	Delta Low to High	0.031	0.037	0.043	0.051	0.071	ns/pF
$d_{THL}^4$	Delta High to Low	0.017	0.017	0.023	0.023	0.037	ns/pF
$d_{THLS}^4$	Delta High to Low—low slew	0.057	0.06	0.071	0.086	0.117	ns/pF

**Note:**

1. All -3 speed grades have been discontinued.
2. Delays based on 35 pF loading.
3. The equivalent IO Attribute settings for 2.5 V LVC MOS is 2.5 V LVTTL in the software.
4. To obtain the slew rate, substitute the appropriate Delta value, load capacitance, and the  $V_{CCI}$  value into the following equation:  

$$\text{Slew Rate [V/ns]} = (0.1 * V_{CCI} - 0.9 * V_{CCI}) / (C_{load} * d_{T[LH|HL|HLS]})$$
 where  $C_{load}$  is the load capacitance driven by the I/O in pF  
 $d_{T[LH|HL|HLS]}$  is the worst case delta value from the datasheet in ns/pF.

Table 2-28 • A54SX32A Timing Characteristics  
 (Worst-Case Commercial Conditions,  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 3.0\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

<b>Parameter</b>	<b>Description</b>	<b>-3 Speed<sup>1</sup></b>		<b>-2 Speed</b>		<b>-1 Speed</b>		<b>Std. Speed</b>	<b>-F Speed</b>	<b>Units</b>
		<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	
<b>C-Cell Propagation Delays<sup>2</sup></b>										
$t_{PD}$	Internal Array Module	0.8	0.9	1.1	1.2	1.7	ns			
<b>Predicted Routing Delays<sup>3</sup></b>										
$t_{DC}$	FO = 1 Routing Delay, Direct Connect	0.1	0.1	0.1	0.1	0.1	0.1	ns		
$t_{FC}$	FO = 1 Routing Delay, Fast Connect	0.3	0.3	0.3	0.4	0.4	0.6	ns		
$t_{RD1}$	FO = 1 Routing Delay	0.3	0.3	0.4	0.5	0.5	0.6	ns		
$t_{RD2}$	FO = 2 Routing Delay	0.4	0.5	0.5	0.6	0.6	0.8	ns		
$t_{RD3}$	FO = 3 Routing Delay	0.5	0.6	0.7	0.8	0.8	1.1	ns		
$t_{RD4}$	FO = 4 Routing Delay	0.7	0.8	0.9	1.0	1.0	1.4	ns		
$t_{RD8}$	FO = 8 Routing Delay	1.2	1.4	1.5	1.8	1.8	2.5	ns		
$t_{RD12}$	FO = 12 Routing Delay	1.7	2.0	2.2	2.6	2.6	3.6	ns		
<b>R-Cell Timing</b>										
$t_{RCO}$	Sequential Clock-to-Q	0.6	0.7	0.8	0.9	1.3	ns			
$t_{CLR}$	Asynchronous Clear-to-Q	0.5	0.6	0.6	0.8	1.0	ns			
$t_{PRESET}$	Asynchronous Preset-to-Q	0.6	0.7	0.7	0.9	1.2	ns			
$t_{SUD}$	Flip-Flop Data Input Set-Up	0.6	0.7	0.8	0.9	1.2	ns			
$t_{HD}$	Flip-Flop Data Input Hold	0.0	0.0	0.0	0.0	0.0	ns			
$t_{WASYN}$	Asynchronous Pulse Width	1.2	1.4	1.5	1.8	2.5	ns			
$t_{RECASYN}$	Asynchronous Recovery Time	0.3	0.4	0.4	0.5	0.7	ns			
$t_{HASYN}$	Asynchronous Removal Time	0.3	0.3	0.3	0.4	0.6	ns			
$t_{MPW}$	Clock Pulse Width	1.4	1.6	1.8	2.1	2.9	ns			
<b>Input Module Propagation Delays</b>										
$t_{INYH}$	Input Data Pad to Y High 2.5 V LVC MOS	0.6	0.7	0.8	0.9	1.2	ns			
$t_{INYL}$	Input Data Pad to Y Low 2.5 V LVC MOS	1.2	1.3	1.5	1.8	2.5	ns			
$t_{INYH}$	Input Data Pad to Y High 3.3 V PCI	0.5	0.6	0.6	0.7	1.0	ns			
$t_{INYL}$	Input Data Pad to Y Low 3.3 V PCI	0.6	0.7	0.8	0.9	1.3	ns			
$t_{INYH}$	Input Data Pad to Y High 3.3 V LV TTL	0.8	0.9	1.0	1.2	1.6	ns			
$t_{INYL}$	Input Data Pad to Y Low 3.3 V LV TTL	1.4	1.6	1.8	2.2	3.0	ns			

**Notes:**

1. All -3 speed grades have been discontinued.
2. For dual-module macros, use  $t_{PD} + t_{RD1} + t_{PDn}$ ,  $t_{RCO} + t_{RD1} + t_{PDn}$ , or  $t_{PD1} + t_{RD1} + t_{SUD}$ , whichever is appropriate.
3. Routing delays are for typical designs across worst-case operating conditions. These parameters should be used for estimating device performance. Post-route timing analysis or simulation is required to determine actual performance.

Table 2-28 • A54SX32A Timing Characteristics (Continued)  
 (Worst-Case Commercial Conditions,  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 3.0\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

<b>Parameter</b>	<b>Description</b>	<b>-3 Speed<sup>1</sup></b>	<b>-2 Speed</b>	<b>-1 Speed</b>	<b>Std. Speed</b>	<b>-F Speed</b>	<b>Units</b>
		<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	
$t_{INYH}$	Input Data Pad to Y High 5 V PCI	0.7	0.8	0.9	1.0	1.4	ns
$t_{INYL}$	Input Data Pad to Y Low 5 V PCI	0.9	1.1	1.2	1.4	1.9	ns
$t_{INYH}$	Input Data Pad to Y High 5 V TTL	0.9	1.1	1.2	1.4	1.9	ns
$t_{INYL}$	Input Data Pad to Y Low 5 V TTL	1.4	1.6	1.8	2.1	2.9	ns
<b>Input Module Predicted Routing Delays<sup>3</sup></b>							
$t_{IRD1}$	FO = 1 Routing Delay	0.3	0.3	0.3	0.4	0.6	ns
$t_{IRD2}$	FO = 2 Routing Delay	0.4	0.5	0.5	0.6	0.8	ns
$t_{IRD3}$	FO = 3 Routing Delay	0.5	0.6	0.7	0.8	1.1	ns
$t_{IRD4}$	FO = 4 Routing Delay	0.7	0.8	0.9	1	1.4	ns
$t_{IRD8}$	FO = 8 Routing Delay	1.2	1.4	1.5	1.8	2.5	ns
$t_{IRD12}$	FO = 12 Routing Delay	1.7	2	2.2	2.6	3.6	ns

**Notes:**

1. All -3 speed grades have been discontinued.
2. For dual-module macros, use  $t_{PD} + t_{RD1} + t_{PDn}$ ,  $t_{RCO} + t_{RD1} + t_{PDn}$ , or  $t_{PD1} + t_{RD1} + t_{SUD}$ , whichever is appropriate.
3. Routing delays are for typical designs across worst-case operating conditions. These parameters should be used for estimating device performance. Post-route timing analysis or simulation is required to determine actual performance.

Table 2-31 • A54SX32A Timing Characteristics  
 (Worst-Case Commercial Conditions  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 4.75\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

<b>Parameter</b>	<b>Description</b>	<b>-3 Speed*</b>	<b>-2 Speed</b>	<b>-1 Speed</b>	<b>Std. Speed</b>	<b>-F Speed</b>	<b>Units</b>
		<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	
<b>Dedicated (Hardwired) Array Clock Networks</b>							
$t_{HCKH}$	Input Low to High (Pad to R-cell Input)	1.7	1.9	2.2	2.6	4.0	ns
$t_{HCKL}$	Input High to Low (Pad to R-cell Input)	1.7	2.0	2.2	2.6	4.0	ns
$t_{HPWH}$	Minimum Pulse Width High	1.4	1.6	1.8	2.1	2.9	ns
$t_{HPWL}$	Minimum Pulse Width Low	1.4	1.6	1.8	2.1	2.9	ns
$t_{HCKSW}$	Maximum Skew	0.6	0.6	0.7	0.8	1.3	ns
$t_{HP}$	Minimum Period	2.8	3.2	3.6	4.2	5.8	ns
$f_{HMAX}$	Maximum Frequency	357	313	278	238	172	MHz
<b>Routed Array Clock Networks</b>							
$t_{RCKH}$	Input Low to High (Light Load) (Pad to R-cell Input)	2.2	2.5	2.8	3.3	4.7	ns
$t_{RCKL}$	Input High to Low (Light Load) (Pad to R-cell Input)	2.1	2.5	2.8	3.3	4.5	ns
$t_{RCKH}$	Input Low to High (50% Load) (Pad to R-cell Input)	2.4	2.7	3.1	3.6	5.1	ns
$t_{RCKL}$	Input High to Low (50% Load) (Pad to R-cell Input)	2.2	2.6	2.9	3.4	4.7	ns
$t_{RCKH}$	Input Low to High (100% Load) (Pad to R-cell Input)	2.5	2.8	3.2	3.8	5.3	ns
$t_{RCKL}$	Input High to Low (100% Load) (Pad to R-cell Input)	2.4	2.8	3.1	3.7	5.2	ns
$t_{RPWH}$	Minimum Pulse Width High	1.4	1.6	1.8	2.1	2.9	ns
$t_{RPWL}$	Minimum Pulse Width Low	1.4	1.6	1.8	2.1	2.9	ns
$t_{RCKSW}$	Maximum Skew (Light Load)	1.0	1.1	1.3	1.5	2.1	ns
$t_{RCKSW}$	Maximum Skew (50% Load)	1.0	1.1	1.3	1.5	2.1	ns
$t_{RCKSW}$	Maximum Skew (100% Load)	1.0	1.1	1.3	1.5	2.1	ns

**Note:** \*All -3 speed grades have been discontinued.

Table 2-33 • A54SX32A Timing Characteristics  
 (Worst-Case Commercial Conditions  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 3.0\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

<b>Parameter</b>	<b>Description</b>	<b>-3 Speed<sup>1</sup></b>	<b>-2 Speed</b>	<b>-1 Speed</b>	<b>Std. Speed</b>	<b>-F Speed</b>	<b>Units</b>
		<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	
<b>3.3 V PCI Output Module Timing<sup>2</sup></b>							
$t_{DLH}$	Data-to-Pad Low to High	1.9	2.2	2.4	2.9	4.0	ns
$t_{DHL}$	Data-to-Pad High to Low	2.0	2.3	2.6	3.1	4.3	ns
$t_{ENZL}$	Enable-to-Pad, Z to L	1.4	1.7	1.9	2.2	3.1	ns
$t_{ENZH}$	Enable-to-Pad, Z to H	1.9	2.2	2.4	2.9	4.0	ns
$t_{ENLZ}$	Enable-to-Pad, L to Z	2.5	2.8	3.2	3.8	5.3	ns
$t_{ENHZ}$	Enable-to-Pad, H to Z	2.0	2.3	2.6	3.1	4.3	ns
$d_{TLH}^3$	Delta Low to High	0.025	0.03	0.03	0.04	0.045	ns/pF
$d_{THL}^3$	Delta High to Low	0.015	0.015	0.015	0.015	0.025	ns/pF
<b>3.3 V LVTTL Output Module Timing<sup>4</sup></b>							
$t_{DLH}$	Data-to-Pad Low to High	2.6	3.0	3.4	4.0	5.6	ns
$t_{DHL}$	Data-to-Pad High to Low	2.6	3.0	3.3	3.9	5.5	ns
$t_{DHLS}$	Data-to-Pad High to Low—low slew	9.0	10.4	11.8	13.8	19.3	ns
$t_{ENZL}$	Enable-to-Pad, Z to L	2.2	2.6	2.9	3.4	4.8	ns
$t_{ENZLS}$	Enable-to-Pad, Z to L—low slew	15.8	18.9	21.3	25.4	34.9	ns
$t_{ENZH}$	Enable-to-Pad, Z to H	2.6	3.0	3.4	4.0	5.6	ns
$t_{ENLZ}$	Enable-to-Pad, L to Z	2.9	3.3	3.7	4.4	6.2	ns
$t_{ENHZ}$	Enable-to-Pad, H to Z	2.6	3.0	3.3	3.9	5.5	ns
$d_{TLH}^3$	Delta Low to High	0.025	0.03	0.03	0.04	0.045	ns/pF
$d_{THL}^3$	Delta High to Low	0.015	0.015	0.015	0.015	0.025	ns/pF
$d_{THLS}^3$	Delta High to Low—low slew	0.053	0.053	0.067	0.073	0.107	ns/pF

**Notes:**

1. All -3 speed grades have been discontinued.
2. Delays based on 10 pF loading and 25  $\Omega$  resistance.
3. To obtain the slew rate, substitute the appropriate Delta value, load capacitance, and the  $V_{CCI}$  value into the following equation:  

$$\text{Slew Rate [V/ns]} = (0.1 * V_{CCI} - 0.9 * V_{CCI}) / (C_{load} * d_{T[LH|HL|HLS]})$$

where  $C_{load}$  is the load capacitance driven by the I/O in pF.  
 $d_{T[LH|HL|HLS]}$  is the worst case delta value from the datasheet in ns/pF.
4. Delays based on 35 pF loading.

Table 2-36 • A54SX72A Timing Characteristics (Continued)  
 (Worst-Case Commercial Conditions  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 2.25\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

<b>Parameter</b>	<b>Description</b>	<b>-3 Speed*</b>	<b>-2 Speed</b>	<b>-1 Speed</b>	<b>Std. Speed</b>	<b>-F Speed</b>	<b>Units</b>
		<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	
$t_{QCKH}$	Input Low to High (100% Load) (Pad to R-cell Input)	3.0	3.4	3.9	4.6	6.4	ns
$t_{QCHKL}$	Input High to Low (100% Load) (Pad to R-cell Input)	2.9	3.4	3.8	4.5	6.3	ns
$t_{QPWH}$	Minimum Pulse Width High	1.5	1.7	2.0	2.3	3.2	ns
$t_{QPWL}$	Minimum Pulse Width Low	1.5	1.7	2.0	2.3	3.2	ns
$t_{QCKSW}$	Maximum Skew (Light Load)	0.2	0.3	0.3	0.3	0.5	ns
$t_{QCKSW}$	Maximum Skew (50% Load)	0.4	0.5	0.5	0.6	0.9	ns
$t_{QCKSW}$	Maximum Skew (100% Load)	0.4	0.5	0.5	0.6	0.9	ns

**Note:** \*All -3 speed grades have been discontinued.

Table 2-37 • A54SX72A Timing Characteristics  
 (Worst-Case Commercial Conditions  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 3.0\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

<b>Parameter</b>	<b>Description</b>	<b>-3 Speed*</b>		<b>-2 Speed</b>		<b>-1 Speed</b>		<b>Std. Speed</b>	<b>-F Speed</b>	<b>Units</b>
		<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	
<b>Dedicated (Hardwired) Array Clock Networks</b>										
$t_{HCKH}$	Input Low to High (Pad to R-cell Input)	1.6		1.9		2.1		2.5		3.8 ns
$t_{HCKL}$	Input High to Low (Pad to R-cell Input)		1.7		1.9		2.1		2.5	3.8 ns
$t_{HPWH}$	Minimum Pulse Width High	1.5		1.7		2.0		2.3		3.2 ns
$t_{HPWL}$	Minimum Pulse Width Low	1.5		1.7		2.0		2.3		3.2 ns
$t_{HCKSW}$	Maximum Skew		1.4		1.6		1.8		2.1	3.3 ns
$t_{HP}$	Minimum Period	3.0		3.4		4.0		4.6		6.4 ns
$f_{HMAX}$	Maximum Frequency		333		294		250		217	156 MHz
<b>Routed Array Clock Networks</b>										
$t_{RCKH}$	Input Low to High (Light Load) (Pad to R-cell Input)	2.2		2.6		2.9		3.4		4.8 ns
$t_{RCKL}$	Input High to Low (Light Load) (Pad to R-cell Input)		2.8		3.3		3.7		4.3	6.0 ns
$t_{RCKH}$	Input Low to High (50% Load) (Pad to R-cell Input)	2.4		2.8		3.2		3.7		5.2 ns
$t_{RCKL}$	Input High to Low (50% Load) (Pad to R-cell Input)		2.9		3.4		3.8		4.5	6.2 ns
$t_{RCKH}$	Input Low to High (100% Load) (Pad to R-cell Input)	2.6		3.0		3.4		4.0		5.6 ns
$t_{RCKL}$	Input High to Low (100% Load) (Pad to R-cell Input)		3.1		3.6		4.1		4.8	6.7 ns
$t_{RPWH}$	Minimum Pulse Width High	1.5		1.7		2.0		2.3		3.2 ns
$t_{RPWL}$	Minimum Pulse Width Low	1.5		1.7		2.0		2.3		3.2 ns
$t_{RCKSW}$	Maximum Skew (Light Load)		1.9		2.2		2.5		3	4.1 ns
$t_{RCKSW}$	Maximum Skew (50% Load)	1.9		2.1		2.4		2.8		3.9 ns
$t_{RCKSW}$	Maximum Skew (100% Load)	1.9		2.1		2.4		2.8		3.9 ns
<b>Quadrant Array Clock Networks</b>										
$t_{QCKH}$	Input Low to High (Light Load) (Pad to R-cell Input)	1.3		1.5		1.7		1.9		2.7 ns
$t_{QCHKL}$	Input High to Low (Light Load) (Pad to R-cell Input)		1.3		1.5		1.7		2	2.8 ns
$t_{QCKH}$	Input Low to High (50% Load) (Pad to R-cell Input)	1.5		1.7		1.9		2.2		3.1 ns
$t_{QCHKL}$	Input High to Low (50% Load) (Pad to R-cell Input)	1.5		1.8		2		2.3		3.2 ns

**Note:** \*All -3 speed grades have been discontinued.

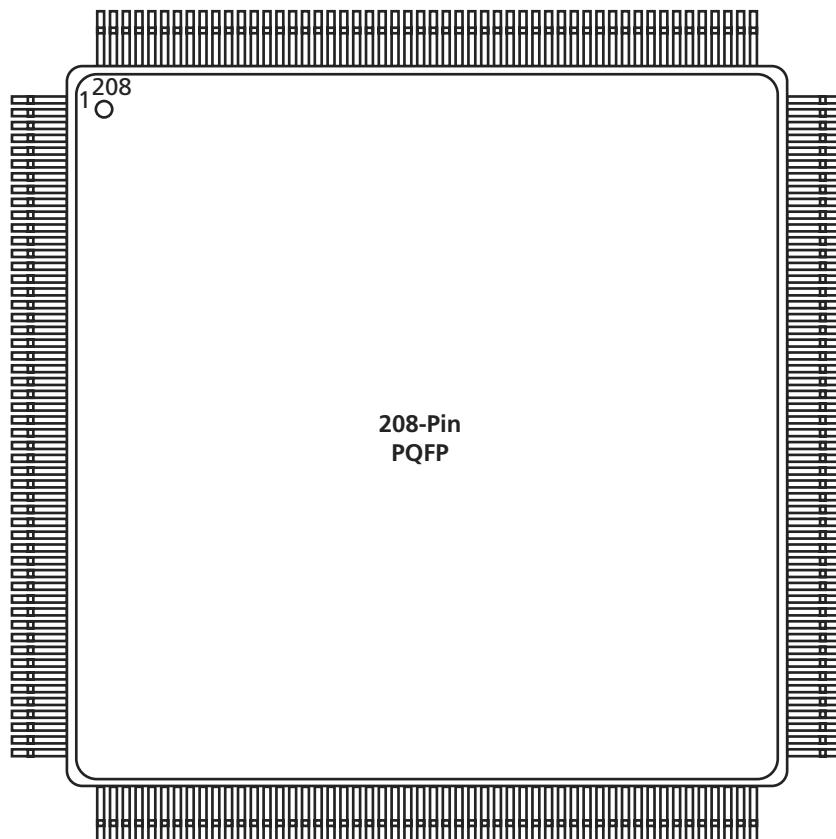
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# Package Pin Assignments

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## 208-Pin PQFP

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Figure 3-1 • 208-Pin PQFP (Top View)

### Note

For Package Manufacturing and Environmental information, visit Resource center at  
<http://www.actel.com/products/rescenter/package/index.html>.

<b>208-Pin PQFP</b>				
<b>Pin Number</b>	<b>A54SX08A Function</b>	<b>A54SX16A Function</b>	<b>A54SX32A Function</b>	<b>A54SX72A Function</b>
71	I/O	I/O	I/O	I/O
72	I/O	I/O	I/O	I/O
73	NC	I/O	I/O	I/O
74	I/O	I/O	I/O	QCLKA
75	NC	I/O	I/O	I/O
76	PRB, I/O	PRB, I/O	PRB, I/O	PRB, I/O
77	GND	GND	GND	GND
78	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
79	GND	GND	GND	GND
80	NC	NC	NC	NC
81	I/O	I/O	I/O	I/O
82	HCLK	HCLK	HCLK	HCLK
83	I/O	I/O	I/O	V <sub>CCI</sub>
84	I/O	I/O	I/O	QCLKB
85	NC	I/O	I/O	I/O
86	I/O	I/O	I/O	I/O
87	I/O	I/O	I/O	I/O
88	NC	I/O	I/O	I/O
89	I/O	I/O	I/O	I/O
90	I/O	I/O	I/O	I/O
91	NC	I/O	I/O	I/O
92	I/O	I/O	I/O	I/O
93	I/O	I/O	I/O	I/O
94	NC	I/O	I/O	I/O
95	I/O	I/O	I/O	I/O
96	I/O	I/O	I/O	I/O
97	NC	I/O	I/O	I/O
98	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
99	I/O	I/O	I/O	I/O
100	I/O	I/O	I/O	I/O
101	I/O	I/O	I/O	I/O
102	I/O	I/O	I/O	I/O
103	TDO, I/O	TDO, I/O	TDO, I/O	TDO, I/O
104	I/O	I/O	I/O	I/O
105	GND	GND	GND	GND

<b>208-Pin PQFP</b>				
<b>Pin Number</b>	<b>A54SX08A Function</b>	<b>A54SX16A Function</b>	<b>A54SX32A Function</b>	<b>A54SX72A Function</b>
106	NC	I/O	I/O	I/O
107	I/O	I/O	I/O	I/O
108	NC	I/O	I/O	I/O
109	I/O	I/O	I/O	I/O
110	I/O	I/O	I/O	I/O
111	I/O	I/O	I/O	I/O
112	I/O	I/O	I/O	I/O
113	I/O	I/O	I/O	I/O
114	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
115	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
116	NC	I/O	I/O	GND
117	I/O	I/O	I/O	V <sub>CCA</sub>
118	I/O	I/O	I/O	I/O
119	NC	I/O	I/O	I/O
120	I/O	I/O	I/O	I/O
121	I/O	I/O	I/O	I/O
122	NC	I/O	I/O	I/O
123	I/O	I/O	I/O	I/O
124	I/O	I/O	I/O	I/O
125	NC	I/O	I/O	I/O
126	I/O	I/O	I/O	I/O
127	I/O	I/O	I/O	I/O
128	I/O	I/O	I/O	I/O
129	GND	GND	GND	GND
130	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
131	GND	GND	GND	GND
132	NC	NC	NC	I/O
133	I/O	I/O	I/O	I/O
134	I/O	I/O	I/O	I/O
135	NC	I/O	I/O	I/O
136	I/O	I/O	I/O	I/O
137	I/O	I/O	I/O	I/O
138	NC	I/O	I/O	I/O
139	I/O	I/O	I/O	I/O
140	I/O	I/O	I/O	I/O

<b>144-Pin TQFP</b>			
<b>Pin Number</b>	<b>A54SX08A Function</b>	<b>A54SX16A Function</b>	<b>A54SX32A Function</b>
75	I/O	I/O	I/O
76	I/O	I/O	I/O
77	I/O	I/O	I/O
78	I/O	I/O	I/O
79	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
80	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
81	GND	GND	GND
82	I/O	I/O	I/O
83	I/O	I/O	I/O
84	I/O	I/O	I/O
85	I/O	I/O	I/O
86	I/O	I/O	I/O
87	I/O	I/O	I/O
88	I/O	I/O	I/O
89	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
90	NC	NC	NC
91	I/O	I/O	I/O
92	I/O	I/O	I/O
93	I/O	I/O	I/O
94	I/O	I/O	I/O
95	I/O	I/O	I/O
96	I/O	I/O	I/O
97	I/O	I/O	I/O
98	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
99	GND	GND	GND
100	I/O	I/O	I/O
101	GND	GND	GND
102	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
103	I/O	I/O	I/O
104	I/O	I/O	I/O
105	I/O	I/O	I/O
106	I/O	I/O	I/O
107	I/O	I/O	I/O
108	I/O	I/O	I/O
109	GND	GND	GND
110	I/O	I/O	I/O

<b>144-Pin TQFP</b>			
<b>Pin Number</b>	<b>A54SX08A Function</b>	<b>A54SX16A Function</b>	<b>A54SX32A Function</b>
111	I/O	I/O	I/O
112	I/O	I/O	I/O
113	I/O	I/O	I/O
114	I/O	I/O	I/O
115	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
116	I/O	I/O	I/O
117	I/O	I/O	I/O
118	I/O	I/O	I/O
119	I/O	I/O	I/O
120	I/O	I/O	I/O
121	I/O	I/O	I/O
122	I/O	I/O	I/O
123	I/O	I/O	I/O
124	I/O	I/O	I/O
125	CLKA	CLKA	CLKA
126	CLKB	CLKB	CLKB
127	NC	NC	NC
128	GND	GND	GND
129	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
130	I/O	I/O	I/O
131	PRA, I/O	PRA, I/O	PRA, I/O
132	I/O	I/O	I/O
133	I/O	I/O	I/O
134	I/O	I/O	I/O
135	I/O	I/O	I/O
136	I/O	I/O	I/O
137	I/O	I/O	I/O
138	I/O	I/O	I/O
139	I/O	I/O	I/O
140	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
141	I/O	I/O	I/O
142	I/O	I/O	I/O
143	I/O	I/O	I/O
144	TCK, I/O	TCK, I/O	TCK, I/O

<b>176-Pin TQFP</b>	
<b>Pin Number</b>	<b>A54SX32A Function</b>
1	GND
2	TDI, I/O
3	I/O
4	I/O
5	I/O
6	I/O
7	I/O
8	I/O
9	I/O
10	TMS
11	V <sub>CC1</sub>
12	I/O
13	I/O
14	I/O
15	I/O
16	I/O
17	I/O
18	I/O
19	I/O
20	I/O
21	GND
22	V <sub>CCA</sub>
23	GND
24	I/O
25	TRST, I/O
26	I/O
27	I/O
28	I/O
29	I/O
30	I/O
31	I/O
32	V <sub>CC1</sub>
33	V <sub>CCA</sub>
34	I/O
35	I/O
36	I/O

<b>176-Pin TQFP</b>	
<b>Pin Number</b>	<b>A54SX32A Function</b>
37	I/O
38	I/O
39	I/O
40	I/O
41	I/O
42	I/O
43	I/O
44	GND
45	I/O
46	I/O
47	I/O
48	I/O
49	I/O
50	I/O
51	I/O
52	V <sub>CC1</sub>
53	I/O
54	I/O
55	I/O
56	I/O
57	I/O
58	I/O
59	I/O
60	I/O
61	I/O
62	I/O
63	I/O
64	PRB, I/O
65	GND
66	V <sub>CCA</sub>
67	NC
68	I/O
69	HCLK
70	I/O
71	I/O
72	I/O

<b>176-Pin TQFP</b>	
<b>Pin Number</b>	<b>A54SX32A Function</b>
73	I/O
74	I/O
75	I/O
76	I/O
77	I/O
78	I/O
79	I/O
80	I/O
81	I/O
82	V <sub>CC1</sub>
83	I/O
84	I/O
85	I/O
86	I/O
87	TDO, I/O
88	I/O
89	GND
90	I/O
91	I/O
92	I/O
93	I/O
94	I/O
95	I/O
96	I/O
97	I/O
98	V <sub>CCA</sub>
99	V <sub>CC1</sub>
100	I/O
101	I/O
102	I/O
103	I/O
104	I/O
105	I/O
106	I/O
107	I/O
108	GND

<b>176-Pin TQFP</b>	
<b>Pin Number</b>	<b>A54SX32A Function</b>
109	V <sub>CCA</sub>
110	GND
111	I/O
112	I/O
113	I/O
114	I/O
115	I/O
116	I/O
117	I/O
118	I/O
119	I/O
120	I/O
121	I/O
122	V <sub>CCA</sub>
123	GND
124	V <sub>CC1</sub>
125	I/O
126	I/O
127	I/O
128	I/O
129	I/O
130	I/O
131	I/O
132	I/O
133	GND
134	I/O
135	I/O
136	I/O
137	I/O
138	I/O
139	I/O
140	V <sub>CC1</sub>
141	I/O
142	I/O
143	I/O
144	I/O

## 329-Pin PBGA

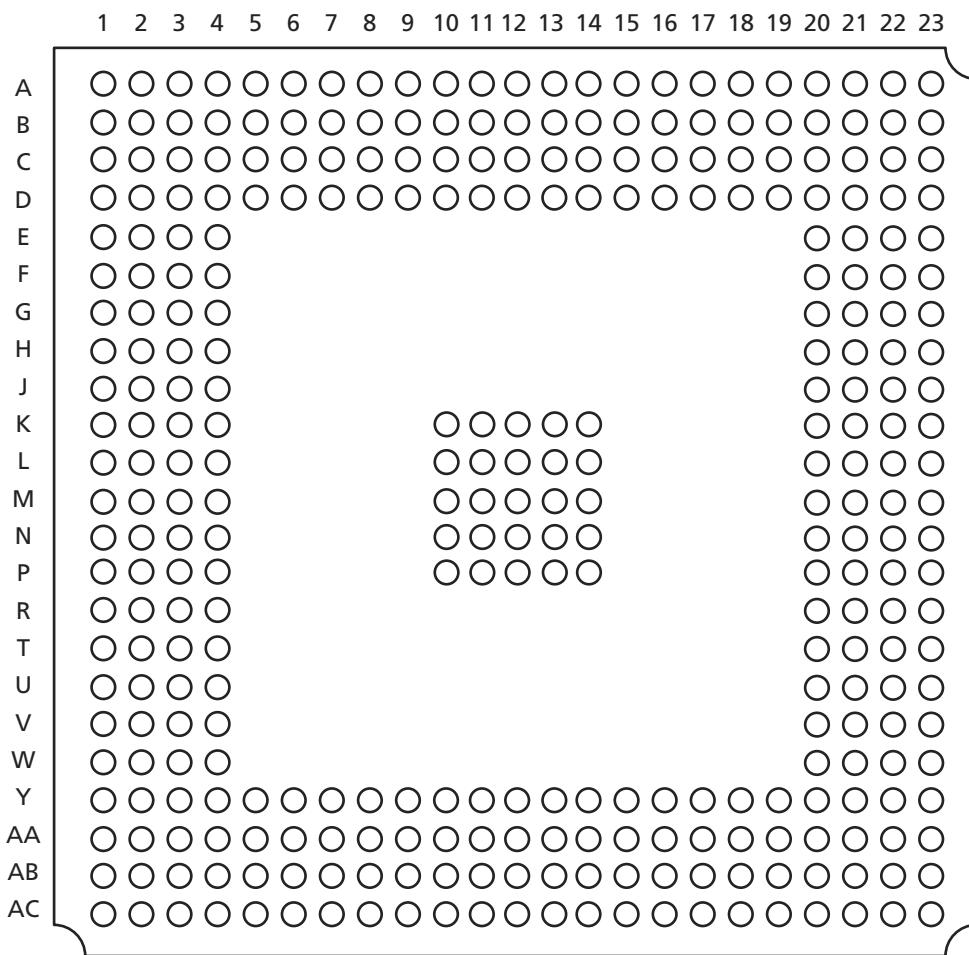


Figure 3-5 • 329-Pin PBGA (Top View)

### Note

For Package Manufacturing and Environmental information, visit Resource center at  
<http://www.actel.com/products/rescenter/package/index.html>.

329-Pin PBGA	
Pin Number	A54SX32A Function
A1	GND
A2	GND
A3	V <sub>CCI</sub>
A4	NC
A5	I/O
A6	I/O
A7	V <sub>CCI</sub>
A8	NC
A9	I/O
A10	I/O
A11	I/O
A12	I/O
A13	CLKB
A14	I/O
A15	I/O
A16	I/O
A17	I/O
A18	I/O
A19	I/O
A20	I/O
A21	NC
A22	V <sub>CCI</sub>
A23	GND
AA1	V <sub>CCI</sub>
AA2	I/O
AA3	GND
AA4	I/O
AA5	I/O
AA6	I/O
AA7	I/O
AA8	I/O
AA9	I/O
AA10	I/O
AA11	I/O
AA12	I/O
AA13	I/O
AA14	I/O

329-Pin PBGA	
Pin Number	A54SX32A Function
AA15	I/O
AA16	I/O
AA17	I/O
AA18	I/O
AA19	I/O
AA20	TDO, I/O
AA21	V <sub>CCI</sub>
AA22	I/O
AA23	V <sub>CCI</sub>
AB1	I/O
AB2	GND
AB3	I/O
AB4	I/O
AB5	I/O
AB6	I/O
AB7	I/O
AB8	I/O
AB9	I/O
AB10	I/O
AB11	PRB, I/O
AB12	I/O
AB13	HCLK
AB14	I/O
AB15	I/O
AB16	I/O
AB17	I/O
AB18	I/O
AB19	I/O
AB20	I/O
AB21	I/O
AB22	GND
AB23	I/O
AC1	GND
AC2	V <sub>CCI</sub>
AC3	NC
AC4	I/O
AC5	I/O

329-Pin PBGA	
Pin Number	A54SX32A Function
AC6	I/O
AC7	I/O
AC8	I/O
AC9	V <sub>CCI</sub>
AC10	I/O
AC11	I/O
AC12	I/O
AC13	I/O
AC14	I/O
AC15	NC
AC16	I/O
AC17	I/O
AC18	I/O
AC19	I/O
AC20	I/O
AC21	NC
AC22	V <sub>CCI</sub>
AC23	GND
B1	V <sub>CCI</sub>
B2	GND
B3	I/O
B4	I/O
B5	I/O
B6	I/O
B7	I/O
B8	I/O
B9	I/O
B10	I/O
B11	I/O
B12	PRA, I/O
B13	CLKA
B14	I/O
B15	I/O
B16	I/O
B17	I/O
B18	I/O
B19	I/O

329-Pin PBGA	
Pin Number	A54SX32A Function
B20	I/O
B21	I/O
B22	GND
B23	V <sub>CCI</sub>
C1	NC
C2	TDI, I/O
C3	GND
C4	I/O
C5	I/O
C6	I/O
C7	I/O
C8	I/O
C9	I/O
C10	I/O
C11	I/O
C12	I/O
C13	I/O
C14	I/O
C15	I/O
C16	I/O
C17	I/O
C18	I/O
C19	I/O
C20	I/O
C21	V <sub>CCI</sub>
C22	GND
C23	NC
D1	I/O
D2	I/O
D3	I/O
D4	TCK, I/O
D5	I/O
D6	I/O
D7	I/O
D8	I/O
D9	I/O
D10	I/O

## 256-Pin FBGA

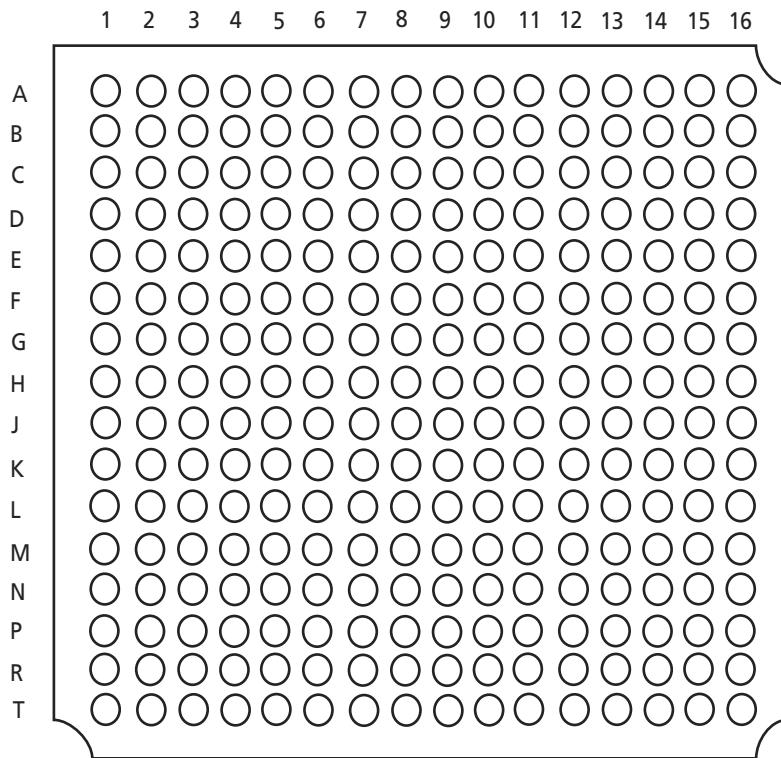


Figure 3-7 • 256-Pin FBGA (Top View)

### Note

For Package Manufacturing and Environmental information, visit Resource center at  
<http://www.actel.com/products/rescenter/package/index.html>.

<b>484-Pin FBGA</b>		
<b>Pin Number</b>	<b>A54SX32A Function</b>	<b>A54SX72A Function</b>
K10	GND	GND
K11	GND	GND
K12	GND	GND
K13	GND	GND
K14	GND	GND
K15	GND	GND
K16	GND	GND
K17	GND	GND
K22	I/O	I/O
K23	I/O	I/O
K24	NC*	NC
K25	NC*	I/O
K26	NC*	I/O
L1	NC*	I/O
L2	NC*	I/O
L3	I/O	I/O
L4	I/O	I/O
L5	I/O	I/O
L10	GND	GND
L11	GND	GND
L12	GND	GND
L13	GND	GND
L14	GND	GND
L15	GND	GND
L16	GND	GND
L17	GND	GND
L22	I/O	I/O
L23	I/O	I/O
L24	I/O	I/O
L25	I/O	I/O
L26	I/O	I/O
M1	NC*	NC
M2	I/O	I/O
M3	I/O	I/O
M4	I/O	I/O

<b>484-Pin FBGA</b>		
<b>Pin Number</b>	<b>A54SX32A Function</b>	<b>A54SX72A Function</b>
M5	I/O	I/O
M10	GND	GND
M11	GND	GND
M12	GND	GND
M13	GND	GND
M14	GND	GND
M15	GND	GND
M16	GND	GND
M17	GND	GND
M22	I/O	I/O
M23	I/O	I/O
M24	I/O	I/O
M25	NC*	I/O
M26	NC*	I/O
N1	I/O	I/O
N2	V <sub>CCI</sub>	V <sub>CCI</sub>
N3	I/O	I/O
N4	I/O	I/O
N5	I/O	I/O
N10	GND	GND
N11	GND	GND
N12	GND	GND
N13	GND	GND
N14	GND	GND
N15	GND	GND
N16	GND	GND
N17	GND	GND
N22	V <sub>CCA</sub>	V <sub>CCA</sub>
N23	I/O	I/O
N24	I/O	I/O
N25	I/O	I/O
N26	NC*	NC
P1	NC*	I/O
P2	NC*	I/O
P3	I/O	I/O

<b>484-Pin FBGA</b>		
<b>Pin Number</b>	<b>A54SX32A Function</b>	<b>A54SX72A Function</b>
P4	I/O	I/O
P5	V <sub>CCA</sub>	V <sub>CCA</sub>
P10	GND	GND
P11	GND	GND
P12	GND	GND
P13	GND	GND
P14	GND	GND
P15	GND	GND
P16	GND	GND
P17	GND	GND
P22	I/O	I/O
P23	I/O	I/O
P24	V <sub>CCI</sub>	V <sub>CCI</sub>
P25	I/O	I/O
P26	I/O	I/O
R1	NC*	I/O
R2	NC*	I/O
R3	I/O	I/O
R4	I/O	I/O
R5	TRST, I/O	TRST, I/O
R10	GND	GND
R11	GND	GND
R12	GND	GND
R13	GND	GND
R14	GND	GND
R15	GND	GND
R16	GND	GND
R17	GND	GND
R22	I/O	I/O
R23	I/O	I/O
R24	I/O	I/O
R25	NC*	I/O
R26	NC*	I/O
T1	NC*	I/O
T2	NC*	I/O

**Note:** \*These pins must be left floating on the A54SX32A device.